

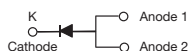
## High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

Ultra Low  $V_F = 0.34$  V at  $I_F = 5$  A

TMBS® eSMP® Series



TO-277A (SMPC)



### FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- **Halogen-free according to IEC 61249-2-21 definition**



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

### MECHANICAL DATA

**Case:** TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	10 A
$V_{RRM}$	45 V
$I_{FSM}$	180 A
$V_F$ at $I_F = 10$ A	0.41 V
$T_J$ max.	150 °C

### MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	V10P45	UNIT
Device marking code		V1045	
Maximum repetitive peak reverse voltage	$V_{RRM}$	45	V
Maximum DC forward current	$I_F^{(1)}$	10	A
	$I_F^{(2)}$	4.4	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	180	A
Operating junction and storage temperature range	$T_J, T_{STG}$	- 40 to + 150	°C

### Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB  
(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.42	-	V
	I <sub>F</sub> = 10 A			0.48	0.57	
	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 125 °C		0.34	-	
	I <sub>F</sub> = 10 A			0.41	0.50	
Reverse current	V <sub>R</sub> = 45 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	21	800	μA
		T <sub>A</sub> = 125 °C		9	35	mA

**Notes**

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	V10P45	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)</sup>	75	°C/W
	R <sub>θJM</sub> <sup>(2)</sup>	4	

**Notes**

- (1) Free air, mounted on recommended copper pad area; thermal resistance R<sub>θJA</sub> - junction to ambient
- (2) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance R<sub>θJM</sub> - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V10P45-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
V10P45-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel

**RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

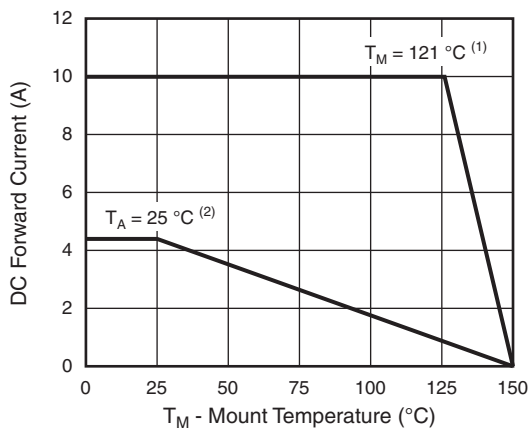


Fig. 1 - Maximum Forward Current Derating Curve

**Notes**

- (1) Mounted on 30 mm x 30 mm aluminum PCB; T<sub>M</sub> measured at the terminal of cathode band (R<sub>θJM</sub> = 4 °C/W)
- (2) Free air, mounted on recommended copper pad area (R<sub>θJA</sub> = 75 °C/W)

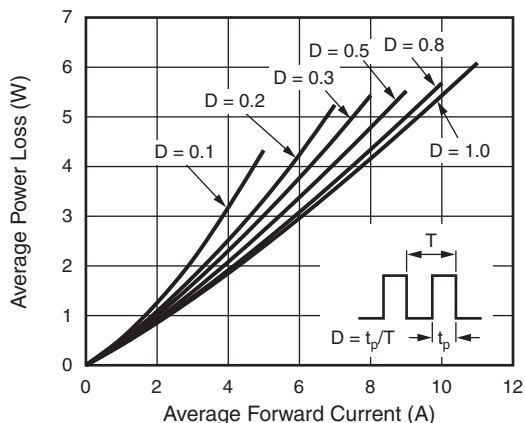


Fig. 2 - Forward Power Loss Characteristics

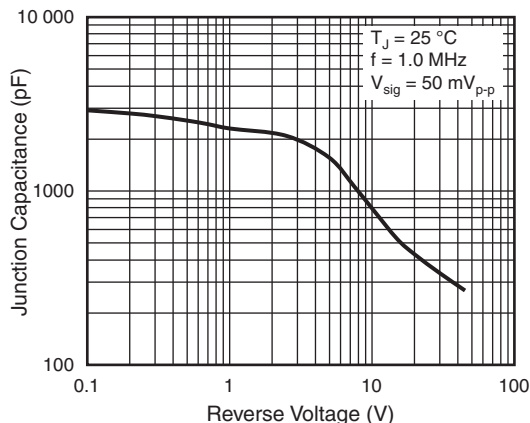


Fig. 5 - Typical Junction Capacitance

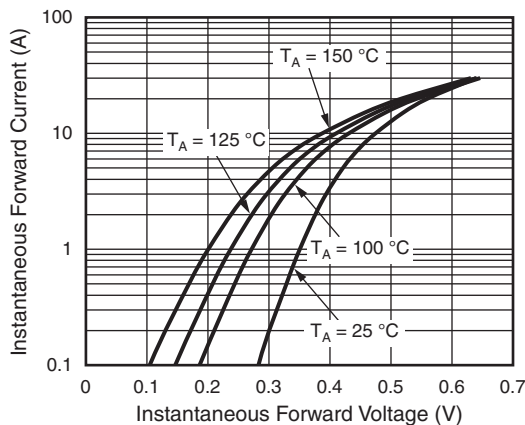


Fig. 3 - Typical Instantaneous Forward Characteristics

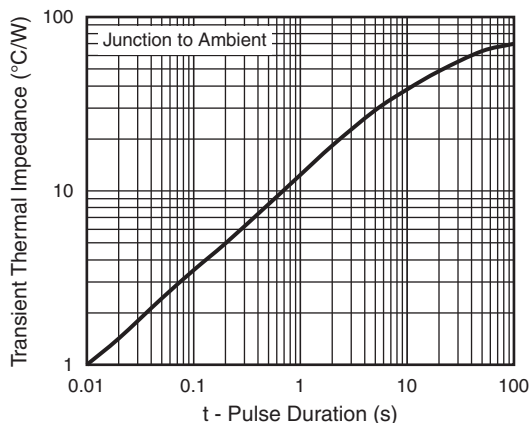


Fig. 6 - Typical Transient Thermal Impedance

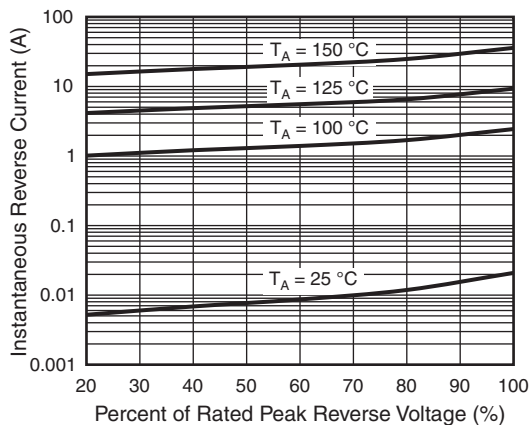
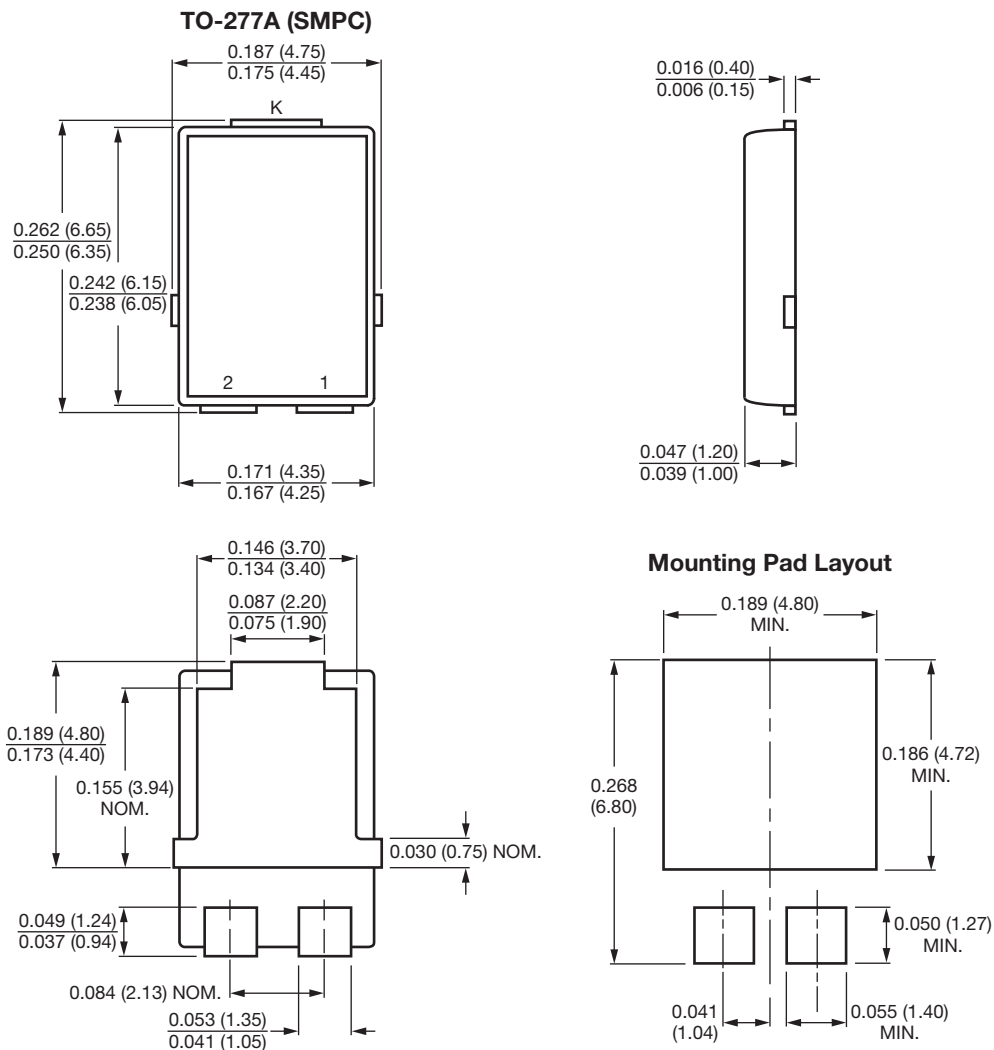


Fig. 4 - Typical Reverse Leakage Characteristics



**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



Conform to JEDEC TO-277A



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